OSRAM SFH 2704A

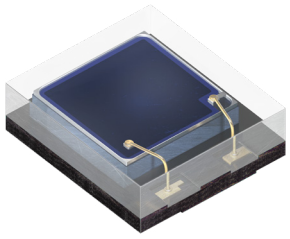
Datasheet

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com
© All rights reserved

Chip LED

SFH 2704A

Silicon PIN Photodiode



Applications

- Digital diagnostic devices
- Vital sign monitoring

Features

- Package: clear epoxy
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Enhanced green sensititvity
- Especially suitable for applications from 400 nm to 1100 nm
- Small package
- Suitable for reflow soldering

Ordering Information

Type	Photocurrent [1] E_e = 0.1 mW/cm²; λ = 535 nm; V_R = 5 V I_P	Photocurrent typ. E_e = 0.1 mW/cm²; λ = 535 nm; V_R = 5 V I_P	Ordering Code
SFH 2704A	≥ 0.49 µA	0.65 µA	Q65113A7342
SFH 2704AH	≥ 0.49 µA	0.65 µA	Q65115A2198

SFH 2704AH: with a harsh surface

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min. max.	-40 °C 85 °C
Storage temperature	T_{stg}	min. max.	-40 °C 85 °C
Reverse voltage	V_R	max.	6 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV

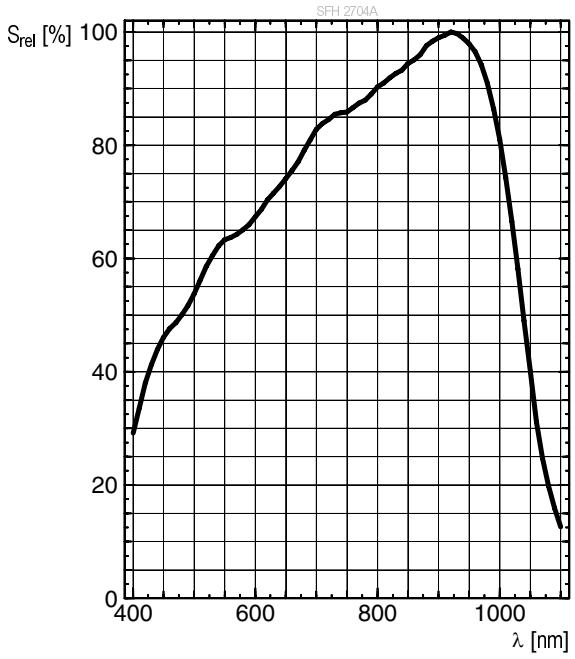
Characteristics

T_A = 25 °C

Parameter	Symbol		Values
Wavelength of max sensitivity	$\lambda_{S\ max}$	typ.	920 nm
Spectral range of sensitivity	$\lambda_{10\%}$	typ.	400 ... 1100 nm
Photocurrent [1)] E_e = 0.1 mW/cm²; λ = 535 nm; V_R = 5 V	I_P	min. typ.	0.49 µA 0.65 µA
Photocurrent E_e = 0.1 mW/cm²; λ = 655 nm; V_R = 5 V	I_P	typ.	0.80 µA
Photocurrent E_e = 0.1 mW/cm²; λ = 950 nm; V_R = 5 V	I_P	typ.	1.0 µA
Photocurrent [1)] E_e = 0.1 mW/cm²; λ = 535 nm; V_R = 0.01 V	I_P	min. typ.	0.49 µA 0.65 µA
Radiant sensitive area	A	typ.	1.51 mm²
Dimensions of active chip area	L x W	typ.	1.23 x 1.23 mm x mm
Half angle	φ	typ.	65 °
Dark current V_R = 5 V; E = 0	I_R	typ. max.	0.15 nA 15 nA
Open-circuit voltage E_e = 0.1 mW/cm²; λ = 535 nm	V_O	typ.	250 mV
Rise time V_R = 5 V; R_L = 50 Ω; λ = 535 nm	t_r	typ.	70 ns
Fall time V_R = 5 V; R_L = 50 Ω; λ = 535 nm	t_f	typ.	80 ns
Forward voltage I_F = 10 mA; E = 0	V_F	typ.	1.0 V
Capacitance V_R = 1 V; f = 1 MHz; E = 0	C	typ.	8.5 pF

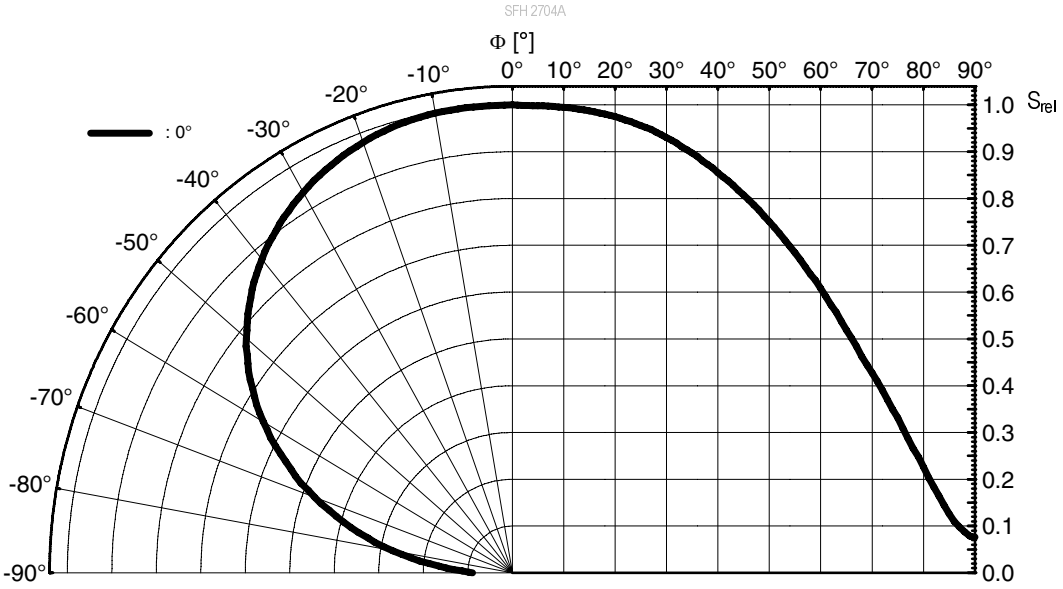
Relative Spectral Sensitivity 2), 3)

$S_{rel} = f(\lambda)$



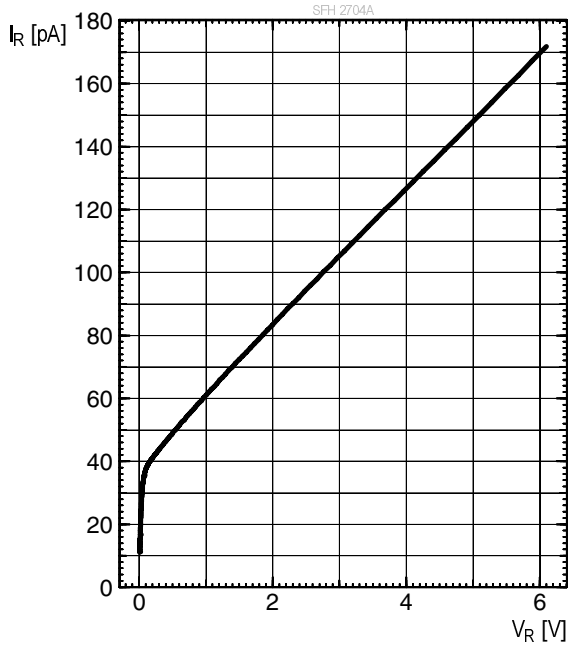
Directional Characteristics 2), 3)

$S_{rel} = f(\varphi)$



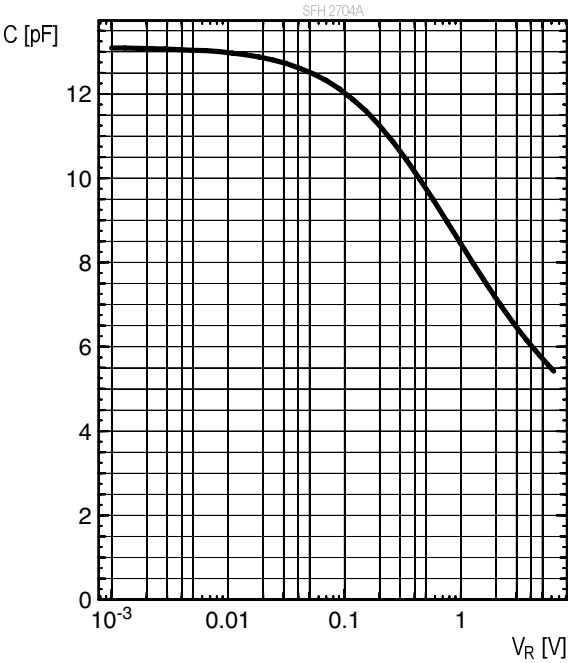
Dark Current 2), 3)

$I_R = f(V_R)$; E = 0

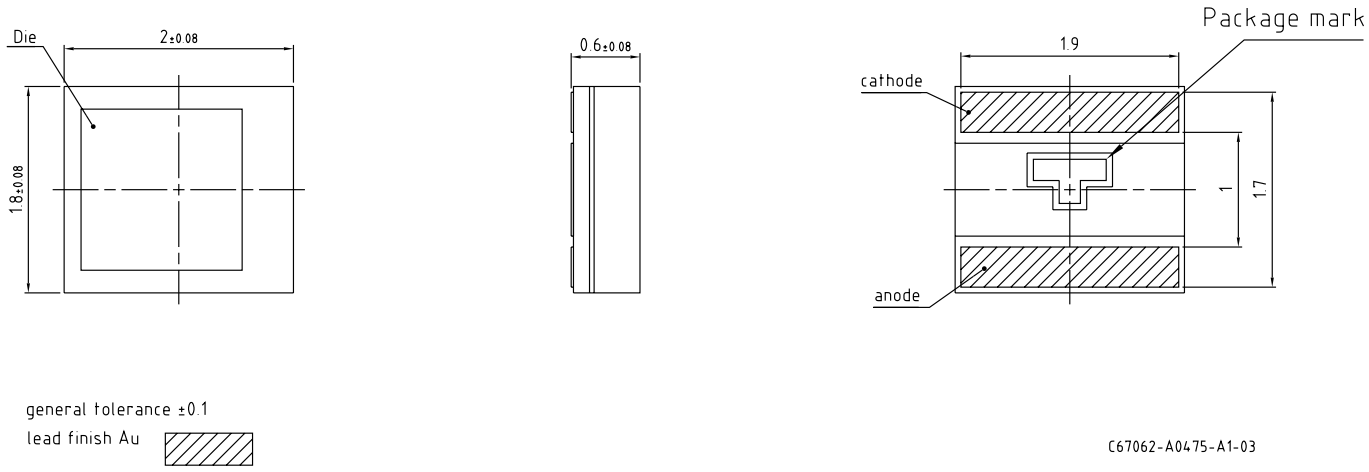


Capacitance 2), 3)

C = f (V_R); f = 1MHz; E = 0; T_A = 25°C



Dimensional Drawing [4)]

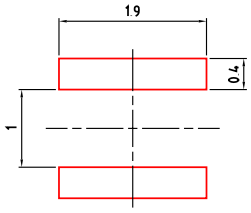


Further Information:

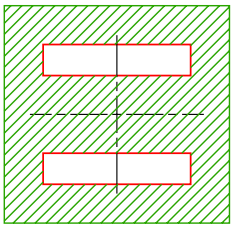
Approximate Weight: 4.4 mg

Package marking: Cathode

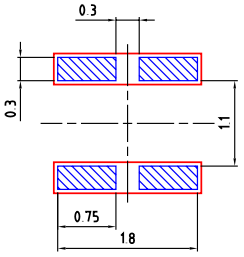
Recommended Solder Pad [4)]



foot print

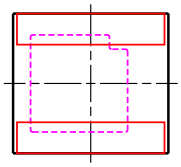


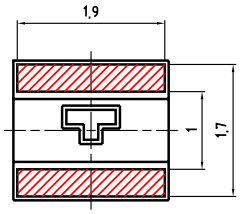
solder resist



solder stencil
recommended stencil
thickness 120µm

Component Location on Pad

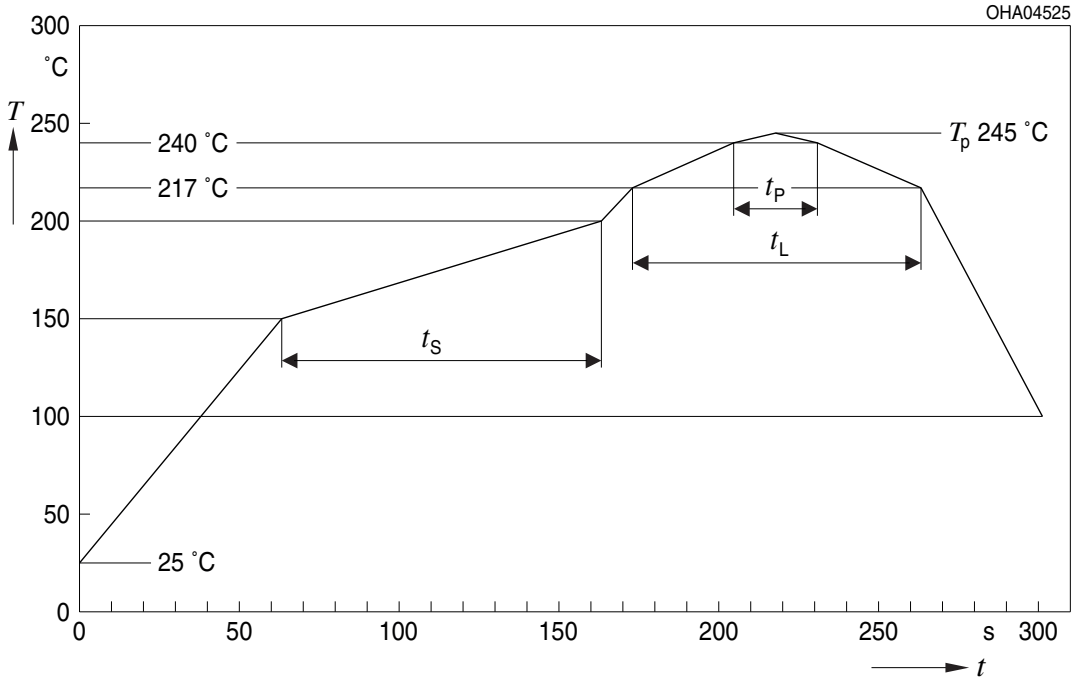




E062.3010.241 -02

Reflow Soldering Profile

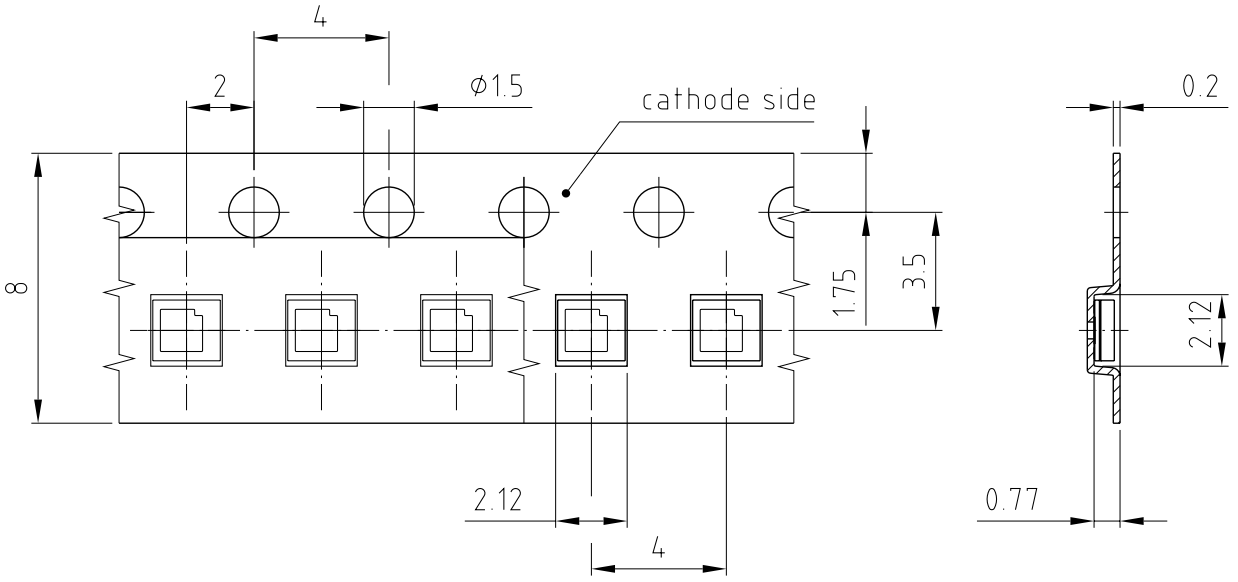
Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

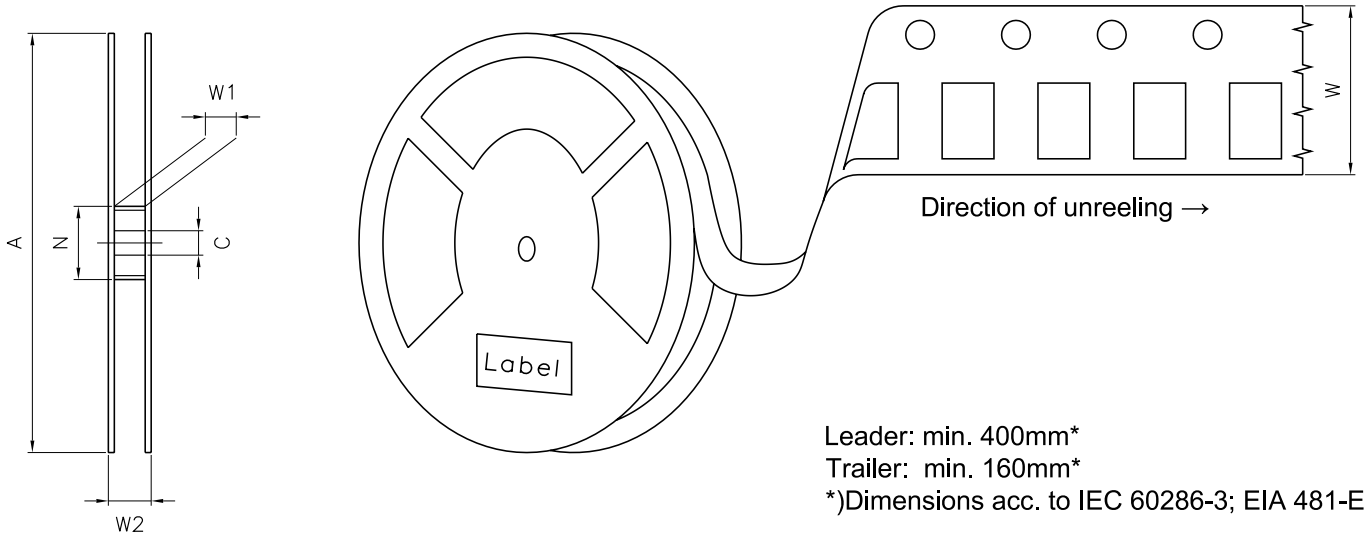
All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping [4)]



C63062-A4367-B1-02

Tape and Reel [5)]

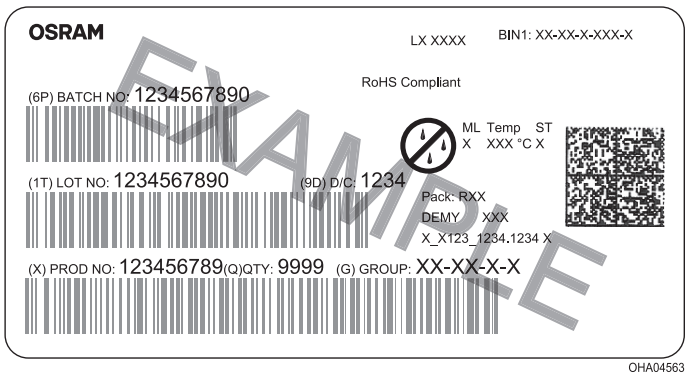


Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

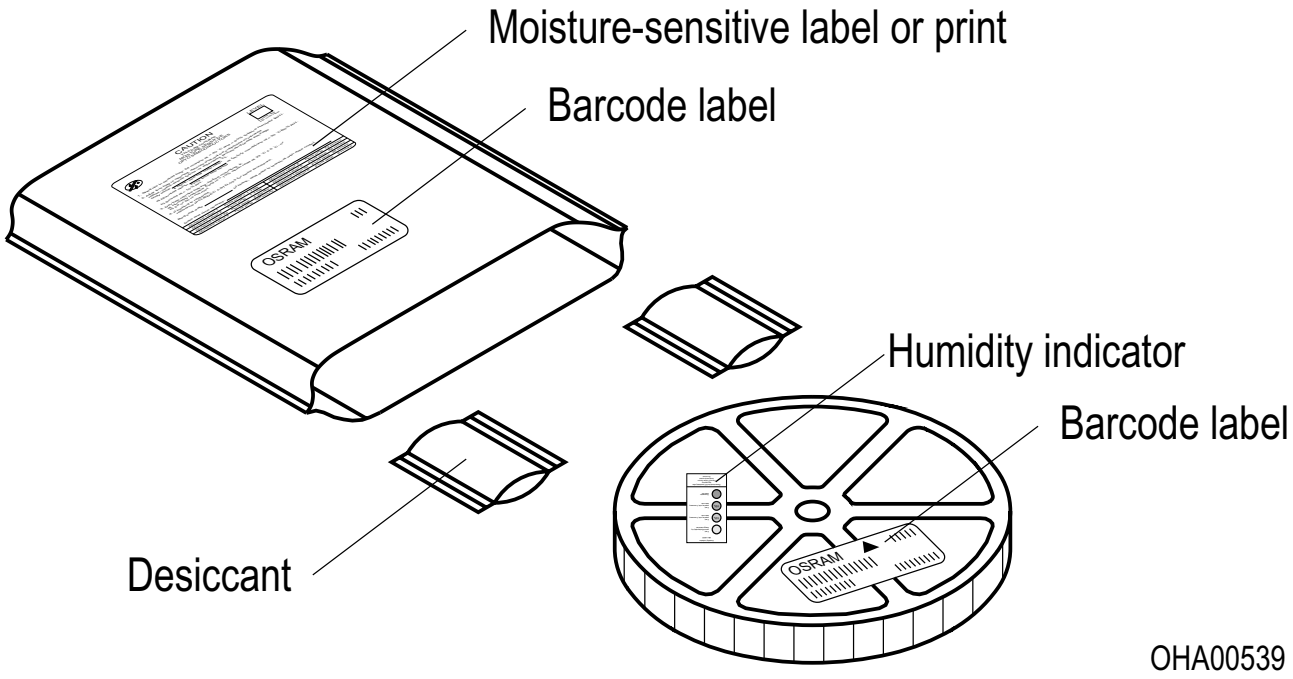
A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	3000

Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials [4)]



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

1) **Photocurrent:** The photocurrent values are measured (by irradiating the devices with a homogenous light source and applying a voltage to the device) with a tolerance of ±11 %.

2) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

3) **Testing temperature:** TA = 25°C (unless otherwise specified)

4) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

5) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2024-01-10	Initial Version
1.1	2025-10-13	Ordering Information
1.2	2026-10-22	Characteristics Product Image

EU RoHS and China RoHS compliant product
此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

Published by ams-OSRAM AG
Tobelbader Strasse 30, 8141 Premstaetten, Austria
Phone +43 3136 500-0
ams-osram.com
© All rights reserved